

AVALANCHE FAST SOFT-RECOVERY RECTIFIER DIODES

Glass passivated rectifier diodes in hermetically sealed axial-leaded glass envelopes. They are intended for television and industrial applications, such as switched-mode power supplies, scan rectifiers, in TV receivers, and also for use in inverter and converter applications. The devices feature non-snap-off (soft-recovery) switching characteristics and are capable of absorbing reverse transient energy (e.g. during flashover in the picture tube).

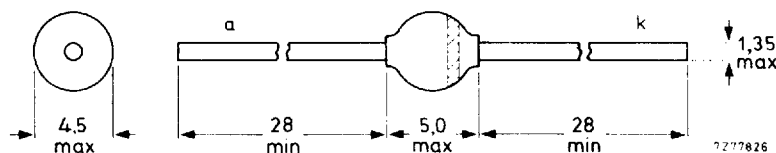
QUICK REFERENCE DATA

			BYW95A	B	C
Repetitive peak reverse voltage	V_{RRM}	max.	200	400	600 V
Continuous reverse voltage	V_R	max.	200	400	600 V
Average forward current	$I_F(AV)$	max.	3		A
Non-repetitive peak forward current	I_{FSM}	max.	70		A
Non-repetitive peak reverse energy	E_{RSM}	max.	10		mJ
Reverse recovery time	t_{rr}	<	250		ns

MECHANICAL DATA

Dimensions in mm

Fig. 1 SOD-64.



The marking band indicates the cathode.

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

		BYW95A	B	C
Repetitive peak reverse voltage	V_{RRM} max.	200	400	600 V
Continuous reverse voltage	V_R max.	200	400	600 V
Average forward current (averaged over any 20 ms period)				
$T_{tp} = 60^\circ\text{C}$; lead length 10 mm	$I_{F(AV)}$ max.		3	A
$T_{amb} = 65^\circ\text{C}$; Fig. 2	$I_{F(AV)}$ max.		1,25	A
Repetitive peak forward current	I_{FRM} max.		15	A
Non-repetitive peak forward current ($t = 10$ ms; half sine-wave) $T_j = T_{j\text{ max}}$ prior to surge; $V_R = V_{RRM\text{ max}}$	I_{FSM} max.		70	A
Non-repetitive peak reverse avalanche energy; $I_R = 400$ mA; $T_j = T_{j\text{ max}}$ prior to surge; with inductive load switched off	E_{RSM} max.		10	mJ
Storage temperature	T_{stg}	-65 to + 175		$^\circ\text{C}$
Operating junction temperature	T_j max.		175	$^\circ\text{C}$

THERMAL RESISTANCE

Influence of mounting method

1. Thermal resistance from junction to tie-point at a lead length of 10 mm
2. Thermal resistance from junction to ambient when mounted on a 1,5 mm thick epoxy-glass printed-circuit board; Cu-thickness $\geq 40 \mu\text{m}$; Fig. 2 (see "Thermal model")

$$R_{th\ j-tp} = 25 \text{ K/W}$$

$$R_{th\ j-a} = 75 \text{ K/W}$$

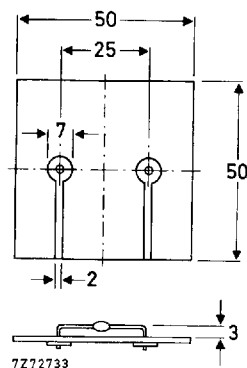


Fig. 2 Mounted on a printed-circuit board.

CHARACTERISTICS

 $T_j = 25^\circ\text{C}$ unless otherwise specified

Forward voltage

$I_F = 5\text{ A}$

$I_F = 5\text{ A}; T_j = T_{j\text{ max}}$

Reverse avalanche breakdown voltage

$I_R = 0,1\text{ mA}$

Reverse current

$V_R = V_{RRM\text{ max}}; T_j = 165^\circ$

Reverse recovery when switched from

$I_F = 1\text{ A to } V_R \geq 30\text{ V with}$

$-dI_F/dt = 20\text{ A}/\mu\text{s}$

recovered charge

recovery time

Maximum slope of reverse recovery current
when switched from $I_F = 1\text{ A}$ to $V_R \geq 30\text{ V}$
with $-dI_F/dt = 1\text{ A}/\mu\text{s}$

	BYW95A	B	C
--	--------	---	---

V_F	<	1,5	1,5	1,5 V *
-------	---	-----	-----	---------

V_F	<	1,25	1,25	1,25 V *
-------	---	------	------	----------

$V_{(BR)R}$	>	300	500	700 V
-------------	---	-----	-----	-------

I_R	<	150		μA
-------	---	-----	--	---------------

Q_s	<	250		nC
-------	---	-----	--	----

t_{rr}	<	250		ns
----------	---	-----	--	----

$ dI_R/dt $	<	6		A/ μs
-------------	---	---	--	------------------

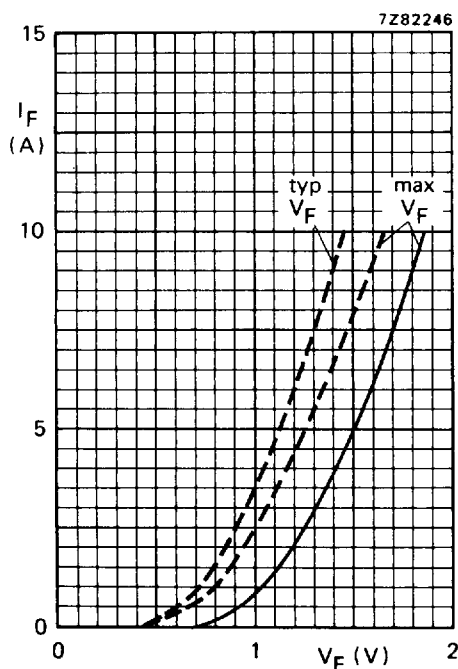
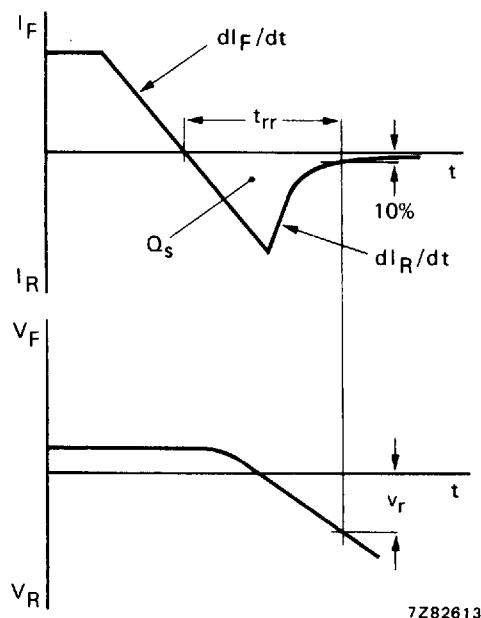
Fig. 3 — $T_j = 25^\circ\text{C}$; --- $T_j = T_{j\text{ max}}$.

Fig. 4 Definitions.

* Measured under pulse conditions to avoid excessive dissipation.

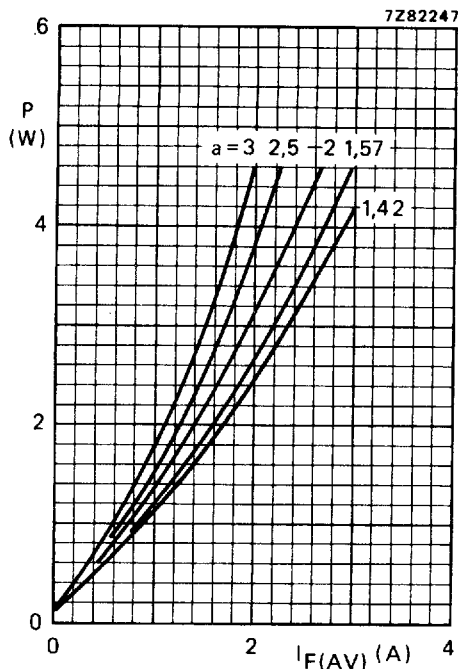


Fig. 5.

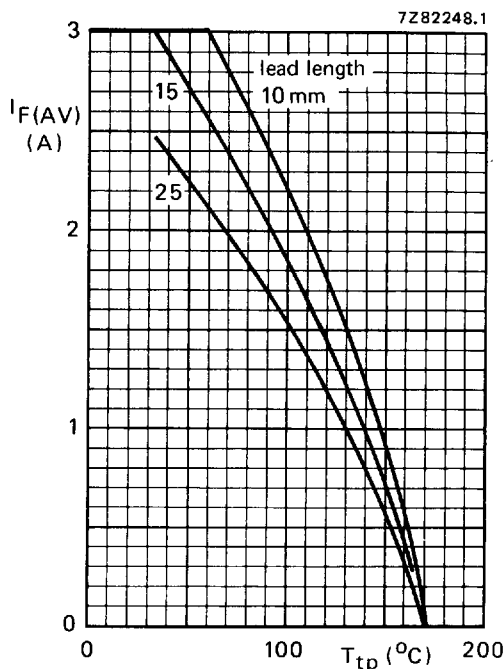


Fig. 6.

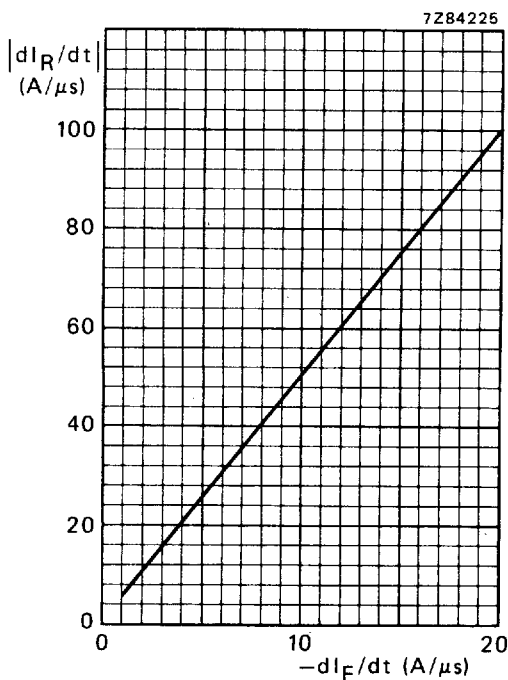


Fig. 7.

Fig. 5 Steady state power dissipation (forward plus leakage current) excluding switching losses as a function of the average forward current.

The graph is for switched-mode application.

$a = I_F(RMS)/I_F(AV)$; $V_R = V_{RRMmax}$

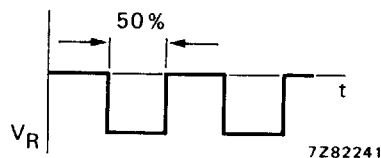


Fig. 6 Maximum average forward current as a function of the tie-point temperature; the curves include losses due to reverse leakage.

The graph is for switched-mode application;

$V_R = V_{RRMmax}$; $\delta = 50\%$; $a = 1,57$.

Fig. 7 Maximum slope of reverse recovery current, $T_j = 25^\circ C$.

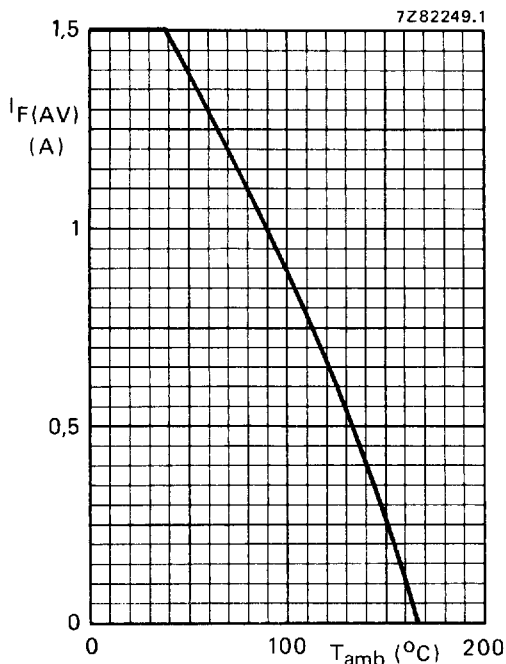


Fig. 8 Maximum average forward current as a function of the ambient temperature; the curve includes losses due to reverse leakage.
 Mounting method see Fig. 2.

The graph is for switched-mode application;
 $V_R = V_{RRMmax}$; $\delta = 50\%$; $a = 1,57$.

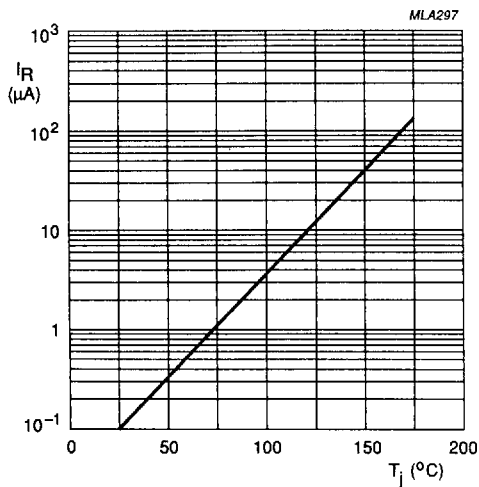


Fig. 9 Reverse current as a function of junction temperature. $V_R = V_{RRMmax}$. Typical values.

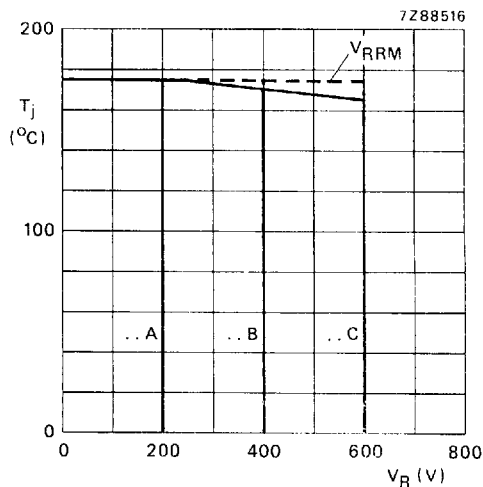


Fig. 10 Maximum values junction temperature as a function of reverse voltage.

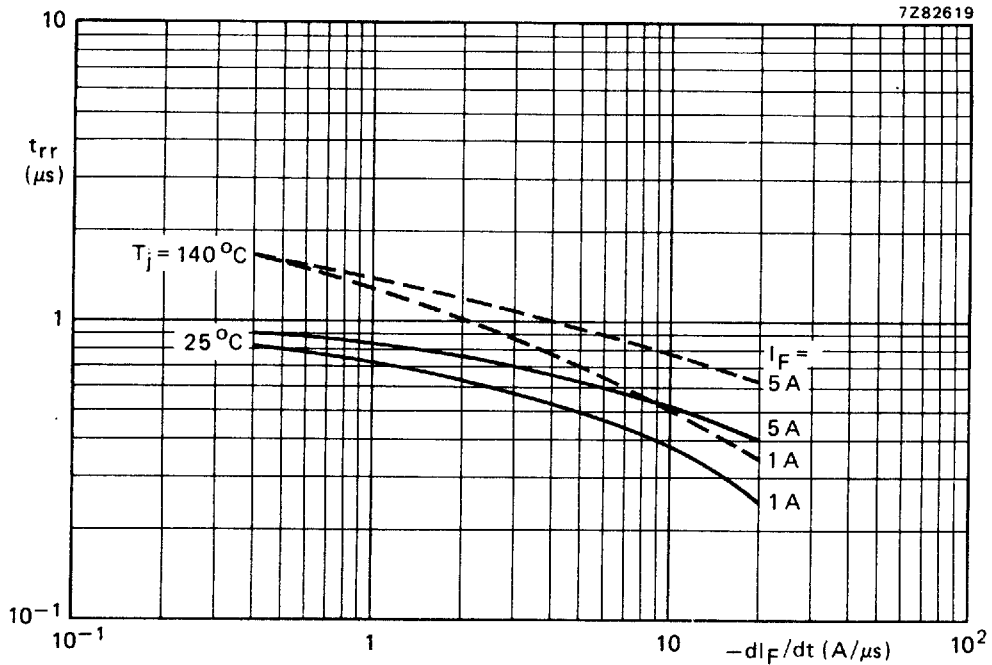


Fig. 11 Maximum values; for definitions see Fig. 4.

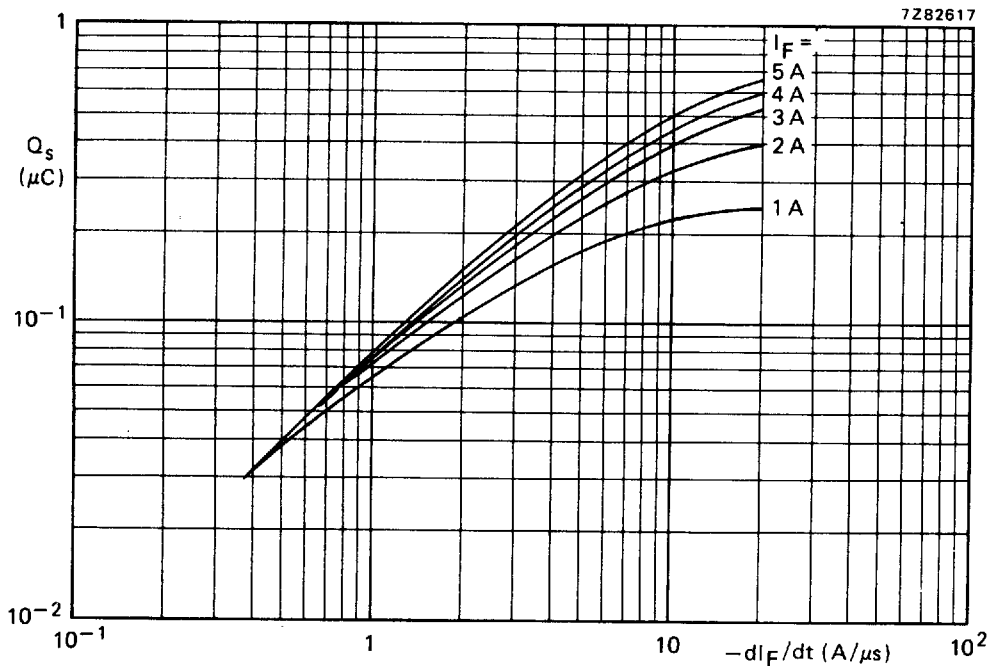


Fig. 12 Maximum values; $T_j = 25^\circ C$. For definitions see Fig. 4.

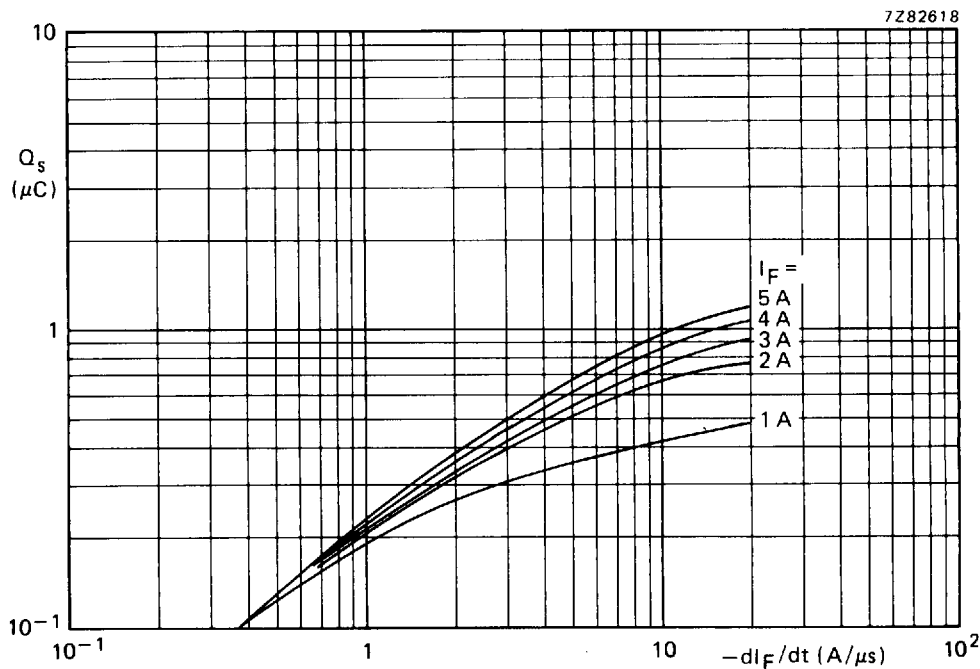


Fig. 13 Maximum values; $T_j = 140^\circ\text{C}$. For definitions see Fig. 4.